

1c997 U.S. PTO  
10/057448

01/25/02

# BEST AVAILABLE COPY

U.S. UTILITY Patent Application

PATENT NUMBER and  
ISSUE DATE

11/05/03

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10057448	01/25/2002	257	693	2815	Warren

**\*\*APPLICANTS:** Wang Daniel;

**\*\*CONTINUING DATA VERIFIED:**  
THIS APPLICATION IS A CON OF 08/761,365 12/09/1996 ABN

**\*\* FOREIGN APPLICATIONS VERIFIED:**

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no Verified and Acknowledged Examiners's initials		ATTORNEY DOCKET NO 669-77 CON
TITLE : High density integrated circuits and the method of packaging the same		

U.S. DEPT. OF COMM./PAT & TM-PTO-435L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
Assistant Examiner		DRAWING	
ISSUE FEE		Sheets Drwg.	Figs. Drwg.
Amount Due	Date Paid	Print Fig.	
Primary Examiner		Application Examiner	
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	
WARNING: The information disclosed herein may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368, Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only.			

FILED WITH: ☐ DISK (CRF) ☐ CD-ROM  
(Attached in pocket on right inside flap)